IRLD024

Vishay Siliconix



HVMDIP

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{qs} (nC)

Q_{ad} (nC)

Qg (Max.) (nC)

Configuration

Power MOSFET

s

N-Channel MOSFET

0.10

60

18

4.5

12

Single

 $V_{GS} = 5.0 V$

FEATURES

- Dynamic dV/dt rating
- · For automatic insertion
- End stackable
- Logic-level gate drive
- R_{DS(on)} dpecified at V_{GS} = 4 V and 5 V
- 175 °C operating temperature
- Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain servers as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRLD024PbF

ABSOLUTE MAXIMUM RATINGS (T_A	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	60	V		
Gate-source voltage			V _{GS}			± 10
Continuous drain current	V _{GS} at 5.0 V	T _A = 25 °C	- I _D	2.5		
Continuous drain current		T _A = 100 °C		1.8	А	
Pulsed drain current ^a	rrent ^a		I _{DM}	20	1	
Linear derating factor				0.0083	W/°C	
Single pulse avalanche energy ^b			E _{AS}	91	mJ	
Maximum power dissipation $T_A = 25 \text{ °C}$		PD	1.3	W		
Peak diode recovery dV/dt ^c		dV/dt	4.5	V/ns		
Operating junction and storage temperature range		T _J , T _{stg}	- 55 to + 175	°C		
Soldering recommendations (peak temperature)	For 10 s			300 ^d		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 16 mH, R_g = 25 Ω , I_{AS} = 2.5 A (see fig. 12)

c. $I_{SD} \leq 17$ A, $dI/dt \leq 140$ A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq 175 \ ^{\circ}C$

d. 1.6 mm from case

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	120	°C/W

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, $I_D = 1 \text{ mA}$		-	0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}	, , , , , , , , , , , , , , , , , , ,	V _{GS} = ± 10 V	-	-	± 100	nA
	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	25	
Zero Gate Voltage Drain Current		V _{DS} = 48 V,	$V_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$	-	-	250	μA
	Р	$V_{GS} = 5.0 V$	I _D = 1.5A ^b	-	-	0.10	Ω
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 4.0 V$	I _D = 1.3 A ^b	-	-	0.14	
Forward Transconductance	g _{fs}	V _{DS} =	25 V, I _D = 1.5 A ^b	3.7	-	-	S
Dynamic				•			
Input Capacitance	C _{iss}	V _{GS} = 0 V V _{DS} = 25 V f = 1.0 MHz, see fig. 5		-	870	-	pF
Output Capacitance	Coss			-	360	-	
Reverse Transfer Capacitance	C _{rss}			-	53	-	
Total Gate Charge	Qg			-	-	18	
Gate-Source Charge	Q_gs	$V_{GS} = 5.0 V$	I _D = 17 A, V _{DS} = 48 V see fig. 6 and 13 ^b	-	-	4.5	nC
Gate-Drain Charge	Q _{gd}	1		-	-	12	
Turn-On Delay Time	t _{d(on)}			-	11	-	
Rise Time	t _r	$\label{eq:V_DD} \begin{array}{l} V_{DD} = 30 \text{ V}, \text{ I}_D = 17 \text{ A} \\ \text{R}_g = 9.0 \ \Omega, \text{ R}_D = 1.7 \ \Omega, \text{ see fig. } 10^{\text{b}} \end{array}$		-	110	-	- ns
Turn-Off Delay Time	t _{d(off)}			-	23	-	
Fall Time	t _f	1			41	-	
Internal Drain Inductance	L _D	6 mm (0.25") f	Between lead, 6 mm (0.25") from		4.0	-	
Internal Source Inductance	Ls	die contact		-	6.0	-	nH
Drain-Source Body Diode Characteristic	s			•		•	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	2.5	
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction	₹ /	-	-	20	A
Body Diode Voltage	V _{SD}	T _J = 25 °C	, I _S = 2.5 A, V _{GS} = 0 V ^b	-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 17 A, dl/dt = 100 A/µs ^b		-	110	260	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.49	1.5	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	I-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

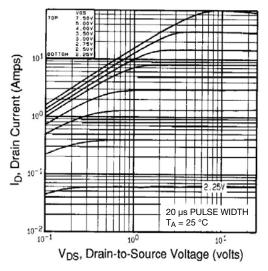


Fig. 1 - Typical Output Characteristics, T_A = 25 °C

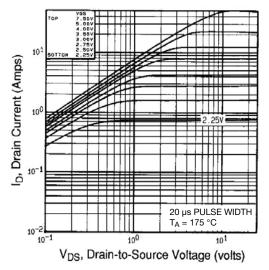


Fig. 2 - Typical Output Characteristics, $T_A = 175 \ ^\circ C$

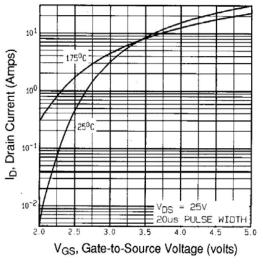


Fig. 3 - Typical Transfer Characteristics

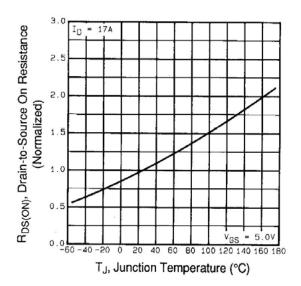


Fig. 4 - Normalized On-Resistance vs. Temperature







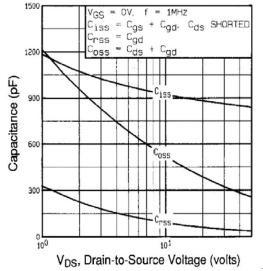


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

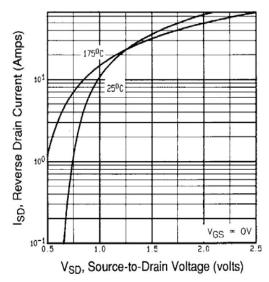


Fig. 7 - Typical Source-Drain Diode Forward Voltage

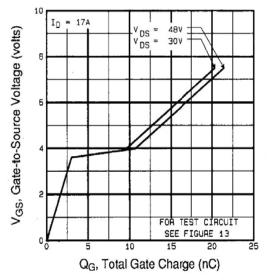


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

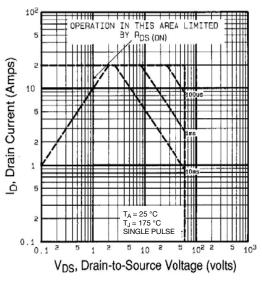


Fig. 8 - Maximum Safe Operating Area

S21-0886-Rev. D, 30-Aug-2021

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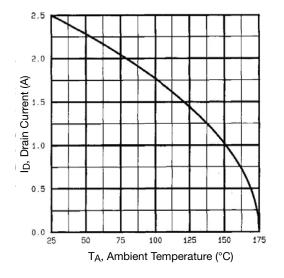


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

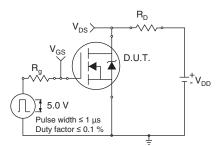


Fig. 10a - Switching Time Test Circuit

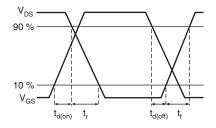


Fig. 10b - Switching Time Waveforms

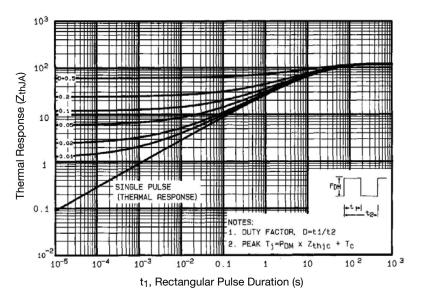


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



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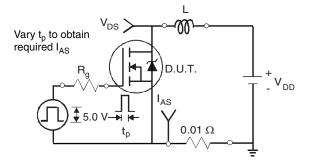


Fig. 12a - Unclamped Inductive Test Circuit

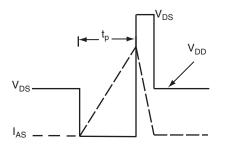


Fig. 12b - Unclamped Inductive Waveforms

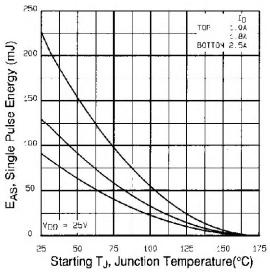
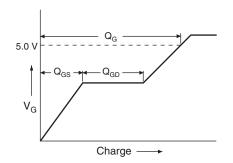
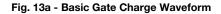


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





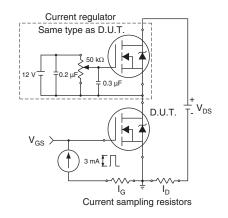


Fig. 13b - Gate Charge Test Circuit

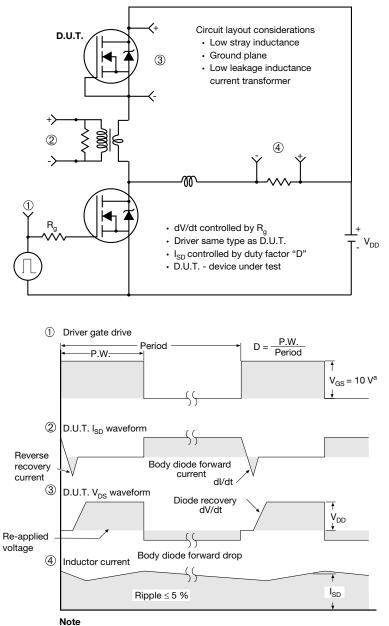
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Peak Diode Recovery dV/dt Test Circuit



a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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